PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3133176

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DAE SUNG EOM	10/29/2014

RECEIVING PARTY DATA

Name:	SK HYNIX INC.	
Street Address:	2091, GYEONGCHUNG-DAERO, BUBAL-EUB	
City:	ICHEON-SI GYEONGGI-DO	
State/Country: KOREA, REPUBLIC OF		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14560638

CORRESPONDENCE DATA

Fax Number: (630)908-7653

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	TORNEY DOCKET NUMBER: PA1886-0	
NAME OF SUBMITTER: WOOCHOON W. PARK		
SIGNATURE:	/Woochoon W. Park/	
DATE SIGNED:	12/04/2014	
This document serves as an Oath/Declaration (37 CFR 1.63).		

Total Attachments: 1

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PATENT 503086571 REEL: 034378 FRAME: 0727

DECLARATION (37 CFR 1.53) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention	SEMICONDUCTOR DEVICE		
Declaration	The above-identified application was a believe that I em the original or application. I hereby acknowledge that any		
Assignment	NOW, THEREFORE, in consideration of the sum of one dollar (\$1), the receipt whereof is acknowledge, and other good and valuable consideration, I, by these presents do sell, assign and transfer unto said assignee(s) [SK hynix inc.] [2091, Gyeongchung-daero, Bubal-eub, Icheon-si, Gyeonggi-do, Republic of Korea] and the heirs, successors, assigns and legal representatives of the assignee(s) the full and exclusive right to the said invention in the United States and in its territorial possessions and in any and all foreign countries any and all improvements thereof, the entire rights, little and interest in and to any and all Patents which may be granted therefore in the United States. I hereby authorize and request the Director of the U.S. Patent and Trademark Office to isspe said United States Patent to said assignee(s), of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made. I agree promptly upon request of the assignee(s), its heirs, successors, assigns and legal representatives of the assignee(s) to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney, Assignment, application, whether original continuation, divisional or reissue, or other papers that may be necessary. I hereby covenant that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale. I further covenant that assignee(s) will, upon its request, be provided promptly with all pertinent facts and documents relating to sald invention and said Letters Patent and legal representatives any and all papers, instruments or afficiavits required to apply for, obtain, maintain, issue and enforce said application, said invention		
Legal Name Of Inventor	Inventor Name (First Middle LAST):	Dae Sung EOM	
	Inventor Signature:	Dae Sving EOM 2014 10, 29	
	Date:	2014 10, 29	

A total of 1 supplemental sheet(s) are attached hereto for additional inventors, if any

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RECORDED: 12/04/2014

REEL: 034378 FRAME: 0728